## 505727882 10/17/2019

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
JONGPAL KIM	10/10/2019

### **RECEIVING PARTY DATA**

Name:	SAMSUNG ELECTRONICS CO., LTD.	
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO	
City:	SUWON-SI	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	16677	

## **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	16655817	

### **CORRESPONDENCE DATA**

**Fax Number:** (202)315-3758

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-429-0020 Email: pto@nsiplaw.com

Correspondent Name: NSIP LAW

Address Line 1: P.O. BOX 65745

Address Line 4: WASHINGTON, D.C. 20035

ATTORNEY DOCKET NUMBER:	012052.1755
NAME OF SUBMITTER:	S. MAHMOOD AHMAD
SIGNATURE:	/S. Mahmood Ahmad/
DATE SIGNED:	10/17/2019

### **Total Attachments: 2**

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PATENT 505727882 REEL: 050749 FRAME: 0666

### COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

#### DECLARATION

As a below-named inventor, I hereby declare that the or to United States Application Number or PCT Inter	is declaration is directed to the application attached hereto
• • • • • • • • • • • • • • • • • • • •	(if applicable), entitled:
	'US FOR MEASURING SIGNAL
The above-identified application was made or autho	rized to be made by me.
I believe I am the original inventor or an original joint application.	t inventor of a claimed invention in the above-identified
I hereby acknowledge that any willful false statement 1001 by fine or imprisonment of not more than five (	nt made in this declaration is punishable under 18 USC 5) years, or both.
I have reviewed and understand the contents of the	above-identified application, including the claims.
me to be material to patentability as defined in 37 Ci	es Patent and Trademark Office all information known to FR 1.56, including for continuation-in-part applications, the filing date of the prior application and the national or art application.
ASS	IGNMENT
For valuable consideration, I, as a below-named ass	signor, hereby assign to:
Samsung Electronics Co., Ltd. 129, Samsung-ro, Yeongtong-gu Suwon-si, Gyeonggi-do 16677 Republic of Korea	
and its successors and assigns (collectively hereina	fter called "the Assignee"), the entire right, title, and
interest throughout the world in the inventions and in	nprovements that are the subject of the application
identified in the above declaration, which is United S Numberfiled on	States Application Number or PCT International Application btober 17, 2019
	ne above-identified application to hereafter complete this per and the filing date of the above-identified application is that may be discovered in this Assignment.
utility models, and design registrations granted for a subject of the above-identified application, and the ridentified application under the International Conver	ight to claim priority based on the filing date of the above- ntion for the Protection of Industrial Property, the Patent on, and all other treaties of like purposes; and I authorize

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registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements

that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may

reasonably request to effectuate fully this Assignment.

# COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Invenior's Legal Name	JongPal KIM		
Inventor's Signature	A. T. K.	Date	Q4.10,7019
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	Samsung Advanced Institute of Technology, 130 Samsung-ro, Youngtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea		

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